

# 74LVC74A

Dual D-type flip-flop with set and reset; positive-edge trigger

Rev. 06 — 4 June 2007

Product data sheet

## 1. General description

The 74LVC74A is a dual edge triggered D-type flip-flop with individual data (D) inputs, clock (CP) inputs, set ( $\overline{SD}$ ) and ( $\overline{RD}$ ) inputs, and complementary Q and  $\overline{Q}$  outputs.

The set and reset are asynchronous active LOW inputs and operate independently of the clock input. Information on the data input is transferred to the Q output on the LOW-to-HIGH transition of the clock pulse. The D inputs must be stable one set-up time prior to the LOW-to-HIGH clock transition, for predictable operation.

Schmitt trigger action at all inputs makes the circuit highly tolerant of slower input rise and fall times.

## 2. Features

- 5 V tolerant inputs for interlacing with 5 V logic
- Wide supply voltage range from 1.2 V to 3.6 V
- CMOS low power consumption
- Direct interface with TTL levels
- Complies with JEDEC standard JESD8-B/JESD36
- ESD protection:
  - ◆ HBM JESD22-A114D exceeds 2000 V
  - ◆ CDM JESD22-C101C exceeds 1000 V
- Specified from  $-40\text{ }^{\circ}\text{C}$  to  $+85\text{ }^{\circ}\text{C}$  and  $-40\text{ }^{\circ}\text{C}$  to  $125\text{ }^{\circ}\text{C}$

## 3. Ordering information

Table 1. Ordering information

| Type number | Package   |          |   | Version  |
|-------------|---|----------|---|----------|
|             | Temperature range   | Name     | Description   |          |
| 74LVC74AD   | $-40\text{ }^{\circ}\text{C}$ to $+125\text{ }^{\circ}\text{C}$ | SO14     | plastic small outline package; 14 leads; body width 3.9 mm  | SOT108-1 |
| 74LVC74ADB  | $-40\text{ }^{\circ}\text{C}$ to $+125\text{ }^{\circ}\text{C}$ | SSOP14   | plastic shrink small outline package; 14 leads; body width 5.3 mm   | SOT337-1 |
| 74LVC74APW  | $-40\text{ }^{\circ}\text{C}$ to $+125\text{ }^{\circ}\text{C}$ | TSSOP14  | plastic thin shrink small outline package; 14 leads; body width 4.4 mm  | SOT402-1 |
| 74LVC74ABQ  | $-40\text{ }^{\circ}\text{C}$ to $+125\text{ }^{\circ}\text{C}$ | DHVQFN14 | plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body $2.5 \times 3 \times 0.85\text{ mm}$ | SOT762-1 |

4. Functional diagram

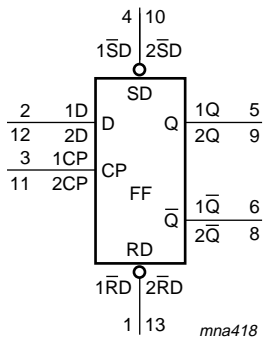


Fig 1. Logic symbol

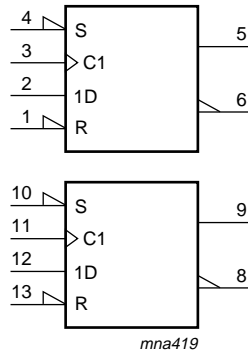


Fig 2. IEC logic symbol

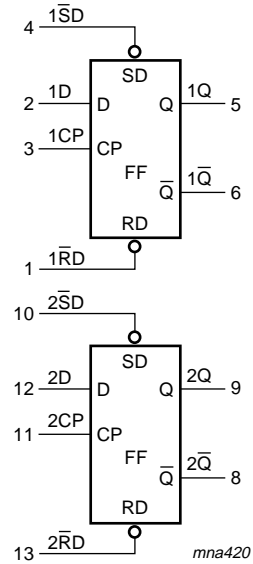


Fig 3. Functional diagram

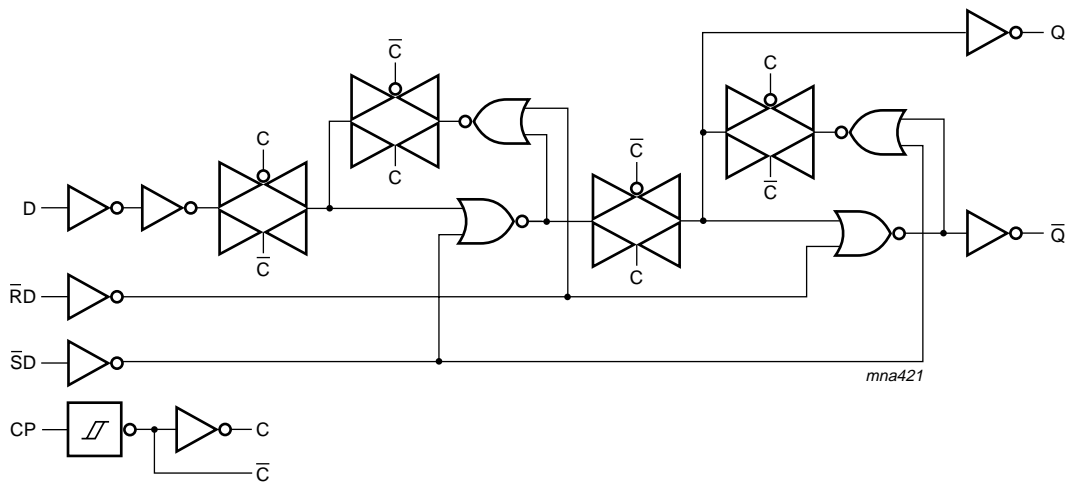
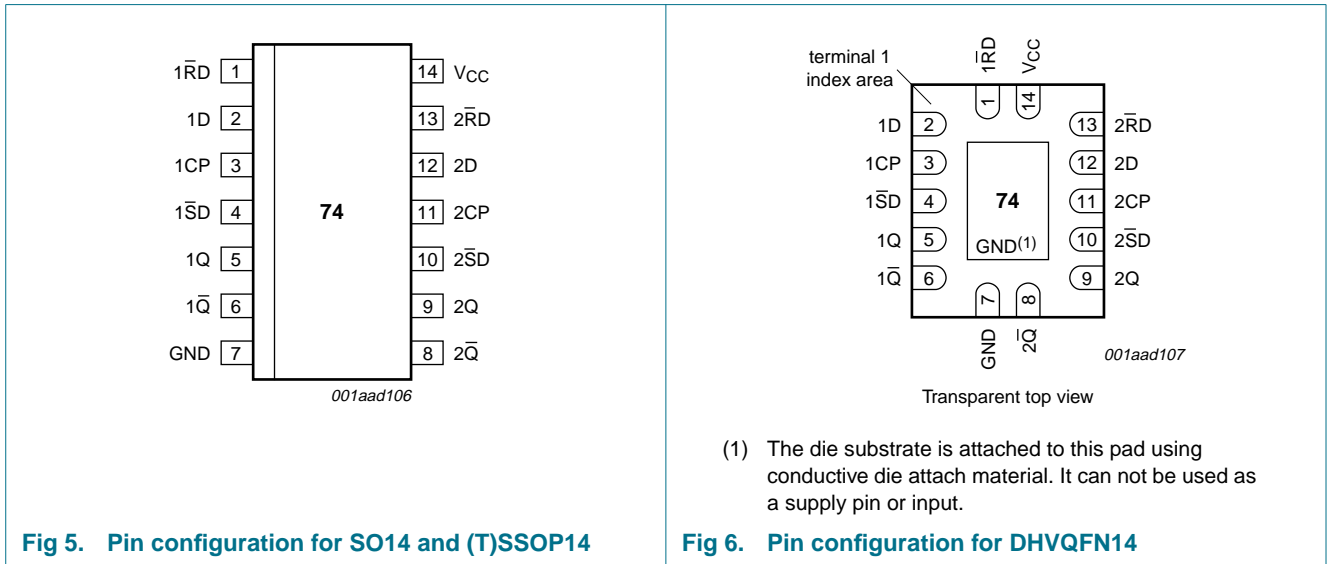


Fig 4. Logic diagram for one flip-flop

## 5. Pinning information

### 5.1 Pinning



### 5.2 Pin description

Table 2. Pin description

| Symbol          | Pin | Description                                  |
|-----------------|-----|--|
| 1 $\bar{R}D$    | 1   | asynchronous reset-direct input (active LOW) |
| 1D              | 2   | data input                                   |
| 1CP             | 3   | clock input (LOW-to-HIGH, edge-triggered)    |
| 1 $\bar{S}D$    | 4   | asynchronous set-direct input (active LOW)   |
| 1Q              | 5   | true output                                  |
| 1 $\bar{Q}$     | 6   | complement output                            |
| GND             | 7   | ground (0 V)                                 |
| 2 $\bar{Q}$     | 8   | complement output                            |
| 2Q              | 9   | true output                                  |
| 2 $\bar{S}D$    | 10  | asynchronous set-direct input (active LOW)   |
| 2CP             | 11  | clock input (LOW-to-HIGH, edge-triggered)    |
| 2D              | 12  | data input                                   |
| 2 $\bar{R}D$    | 13  | asynchronous reset-direct input (active LOW) |
| V <sub>CC</sub> | 14  | supply voltage                               |

## 6. Functional description

Table 3. Function table<sup>[1]</sup>

| Input |     |     |    | Output |    |
|-------|-----|-----|----|--------|----|
| nSD   | nRD | nCP | nD | nQ     | nQ |
| L     | H   | X   | X  | H      | L  |
| H     | L   | X   | X  | L      | H  |
| L     | L   | X   | X  | H      | H  |

- [1] H = HIGH voltage level  
 L = LOW voltage level  
 X = don't care

Table 4. Function table<sup>[1]</sup>

| Input |     |     |    | Output            |                   |
|-------|-----|-----|----|-------------------|-------------------|
| nSD   | nRD | nCP | nD | nQ <sub>n+1</sub> | nQ <sub>n+1</sub> |
| H     | H   | ↑   | L  | L                 | H                 |
| H     | H   | ↑   | H  | H                 | L                 |

- [1] H = HIGH voltage level  
 L = LOW voltage level  
 ↑ = LOW-to-HIGH transition  
 Q<sub>n+1</sub> = state after the next LOW-to-HIGH CP transition  
 X = don't care

## 7. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol           | Parameter               | Conditions   | Min      | Max                   | Unit |
|------------------|-------------------------|--|----------|-----------------------|------|
| V <sub>CC</sub>  | supply voltage          |  | -0.5     | +6.5                  | V    |
| I <sub>IK</sub>  | input clamping current  | V <sub>I</sub> < 0 V                                     | -50      | -                     | mA   |
| V <sub>I</sub>   | input voltage           |  | [1] -0.5 | +6.5                  | V    |
| I <sub>OK</sub>  | output clamping current | V <sub>O</sub> > V <sub>CC</sub> or V <sub>O</sub> < 0 V | -        | ±50                   | mA   |
| V <sub>O</sub>   | output voltage          |  | [2] -0.5 | V <sub>CC</sub> + 0.5 | V    |
| I <sub>O</sub>   | output current          | V <sub>O</sub> = 0 V to V <sub>CC</sub>                  | -        | ±50                   | mA   |
| I <sub>CC</sub>  | supply current          |  | -        | 100                   | mA   |
| I <sub>GND</sub> | ground current          |  | -100     | -                     | mA   |
| T <sub>stg</sub> | storage temperature     |  | -65      | +150                  | °C   |
| P <sub>tot</sub> | total power dissipation | T <sub>amb</sub> = -40 °C to +125 °C                     | [3] -    | 500                   | mW   |

- [1] The minimum input voltage ratings may be exceeded if the input current ratings are observed.  
 [2] The output voltage ratings may be exceeded if the output current ratings are observed.  
 [3] For SO14 packages: above 70 °C the value of P<sub>tot</sub> derates linearly with 8 mW/K.  
 For (T)SSOP14 packages: above 60 °C the value of P<sub>tot</sub> derates linearly with 5.5 mW/K.  
 For DHVQFN14 packages: above 60 °C the value of P<sub>tot</sub> derates linearly with 4.5 mW/K.

## 8. Recommended operating conditions

**Table 6. Recommended operating conditions**

| Symbol           | Parameter                           | Conditions                       | Min | Typ | Max             | Unit |
|------------------|-------------------------------------|----------------------------------|-----|-----|-----------------|------|
| V <sub>CC</sub>  | supply voltage                      | for maximum speed performance    | 2.7 | -   | 3.6             | V    |
|                  |                                     | for low-voltage applications     | 1.2 | -   | 3.6             | V    |
| V <sub>I</sub>   | input voltage                       |                                  | 0   | -   | 5.5             | V    |
| V <sub>O</sub>   | output voltage                      |                                  | 0   | -   | V <sub>CC</sub> | V    |
| T <sub>amb</sub> | ambient temperature                 |                                  | -40 | -   | +125            | °C   |
| Δt/ΔV            | input transition rise and fall rate | V <sub>CC</sub> = 1.2 V to 2.7 V | 0   | -   | 20              | ns/V |
|                  |                                     | V <sub>CC</sub> = 2.7 V to 3.6 V | 0   | -   | 10              | ns/V |

## 9. Static characteristics

**Table 7. Static characteristics**

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

| Symbol           | Parameter                 | Conditions  | -40 °C to +85 °C      |                    |      | -40 °C to +125 °C     |      | Unit |
|------------------|---------------------------|---|-----------------------|--------------------|------|-----------------------|------|------|
|                  |                           |   | Min                   | Typ <sup>[1]</sup> | Max  | Min                   | Max  |      |
| V <sub>IH</sub>  | HIGH-level input voltage  | V <sub>CC</sub> = 1.2 V   | V <sub>CC</sub>       | -                  | -    | V <sub>CC</sub>       | -    | V    |
|                  |                           | V <sub>CC</sub> = 2.7 V to 3.6 V  | 2.0                   | -                  | -    | 2.0                   | -    | V    |
| V <sub>IL</sub>  | LOW-level input voltage   | V <sub>CC</sub> = 1.2 V   | -                     | -                  | 0    | -                     | 0    | V    |
|                  |                           | V <sub>CC</sub> = 2.7 V to 3.6 V  | -                     | -                  | 0.8  | -                     | 0.8  | V    |
| V <sub>OH</sub>  | HIGH-level output voltage | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>   | V <sub>CC</sub> - 0.2 | -                  | -    | V <sub>CC</sub> - 0.3 | -    | V    |
|                  |                           | I <sub>O</sub> = -100 μA; V <sub>CC</sub> = 2.7 V to 3.6 V  |                       |                    |      |                       |      |      |
|                  |                           | I <sub>O</sub> = -12 mA; V <sub>CC</sub> = 2.7 V  | 2.2                   | -                  | -    | 2.05                  | -    | V    |
|                  |                           | I <sub>O</sub> = -18 mA; V <sub>CC</sub> = 3.0 V  | 2.4                   | -                  | -    | 2.25                  | -    | V    |
| V <sub>OL</sub>  | LOW-level output voltage  | I <sub>O</sub> = -24 mA; V <sub>CC</sub> = 3.0 V  | 2.2                   | -                  | -    | 2.0                   | -    | V    |
|                  |                           | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>   |                       |                    |      |                       |      |      |
|                  |                           | I <sub>O</sub> = 100 μA; V <sub>CC</sub> = 2.7 V to 3.6 V   | -                     | -                  | 0.2  | -                     | 0.3  | V    |
| I <sub>I</sub>   | input leakage current     | I <sub>O</sub> = 12 mA; V <sub>CC</sub> = 2.7 V   | -                     | -                  | 0.4  | -                     | 0.6  | V    |
|                  |                           | I <sub>O</sub> = 24 mA; V <sub>CC</sub> = 3.0 V   | -                     | -                  | 0.55 | -                     | 0.8  | V    |
|                  |                           | V <sub>CC</sub> = 3.6 V; V <sub>I</sub> = 5.5 V or GND  | -                     | ±0.1               | ±5   | -                     | ±20  | μA   |
| I <sub>CC</sub>  | supply current            | V <sub>CC</sub> = 3.6 V; V <sub>I</sub> = V <sub>CC</sub> or GND; I <sub>O</sub> = 0 A                          | -                     | 0.1                | 10   | -                     | 40   | μA   |
| ΔI <sub>CC</sub> | additional supply current | per input pin; V <sub>CC</sub> = 2.7 V to 3.6 V; V <sub>I</sub> = V <sub>CC</sub> - 0.6 V; I <sub>O</sub> = 0 A | -                     | 5                  | 500  | -                     | 5000 | μA   |
| C <sub>I</sub>   | input capacitance         | V <sub>CC</sub> = 0 V to 3.6 V; V <sub>I</sub> = GND to V <sub>CC</sub>   | -                     | 4.0                | -    | -                     | -    | pF   |

[1] All typical values are measured at V<sub>CC</sub> = 3.3 V (unless stated otherwise) and T<sub>amb</sub> = 25 °C.

## 10. Dynamic characteristics

**Table 8. Dynamic characteristics**

Voltages are referenced to GND (ground = 0 V). For test circuit see [Figure 9](#).

| Symbol             | Parameter                     | Conditions  | -40 °C to +85 °C |                    |     | -40 °C to +125 °C |     | Unit |
|--------------------|-------------------------------|---|------------------|--------------------|-----|-------------------|-----|------|
|                    |                               |   | Min              | Typ <sup>[1]</sup> | Max | Min               | Max |      |
| t <sub>pd</sub>    | propagation delay             | nCP to nQ, nQ̄; see <a href="#">Figure 7</a> <sup>[2]</sup>           |                  |                    |     |                   |     |      |
|                    |                               | V <sub>CC</sub> = 1.2 V   | -                | 15                 | -   | -                 | -   | ns   |
|                    |                               | V <sub>CC</sub> = 2.7 V   | 1.0              | 2.7                | 6.0 | 1.0               | 7.5 | ns   |
|                    |                               | V <sub>CC</sub> = 3.0 V to 3.6 V                                      | 1.0              | 2.5                | 5.2 | 1.0               | 6.5 | ns   |
|                    |                               | nSD to nQ, nQ̄; see <a href="#">Figure 8</a>                          |                  |                    |     |                   |     |      |
|                    |                               | V <sub>CC</sub> = 1.2 V   | -                | 15                 | -   | -                 | -   | ns   |
|                    |                               | V <sub>CC</sub> = 2.7 V   | 1.0              | 3.2                | 6.4 | 1.0               | 8.0 | ns   |
|                    |                               | V <sub>CC</sub> = 3.0 V to 3.6 V                                      | 1.0              | 2.5                | 5.4 | 1.0               | 7.0 | ns   |
|                    |                               | nRD to nQ, nQ̄; see <a href="#">Figure 8</a>                          |                  |                    |     |                   |     |      |
|                    |                               | V <sub>CC</sub> = 1.2 V   | -                | 15                 | -   | -                 | -   | ns   |
|                    |                               | V <sub>CC</sub> = 2.7 V   | 1.0              | 3.2                | 6.4 | 1.0               | 8.0 | ns   |
|                    |                               | V <sub>CC</sub> = 3.0 V to 3.6 V                                      | 1.0              | 2.5                | 5.4 | 1.0               | 7.0 | ns   |
| t <sub>w</sub>     | pulse width                   | clock HIGH or LOW; see <a href="#">Figure 7</a>                       |                  |                    |     |                   |     |      |
|                    |                               | V <sub>CC</sub> = 2.7 V   | 3.3              | -                  | -   | 4.5               | -   | ns   |
|                    |                               | V <sub>CC</sub> = 3.0 V to 3.6 V                                      | 3.3              | 1.3                | -   | 4.5               | -   | ns   |
|                    |                               | set or reset LOW; see <a href="#">Figure 8</a>                        |                  |                    |     |                   |     |      |
|                    |                               | V <sub>CC</sub> = 2.7 V   | 3.3              | -                  | -   | 4.5               | -   | ns   |
|                    |                               | V <sub>CC</sub> = 3.0 V to 3.6 V                                      | 3.3              | 1.7                | -   | 4.5               | -   | ns   |
| t <sub>rec</sub>   | recovery time                 | set or reset; see <a href="#">Figure 8</a>                            |                  |                    |     |                   |     |      |
|                    |                               | V <sub>CC</sub> = 2.7 V   | 1.5              | -                  | -   | 1.0               | -   | ns   |
|                    |                               | V <sub>CC</sub> = 3.0 V to 3.6 V                                      | +1.0             | -3.0               | -   | 1.0               | -   | ns   |
| t <sub>su</sub>    | set-up time                   | nD to nCP; see <a href="#">Figure 7</a>                               |                  |                    |     |                   |     |      |
|                    |                               | V <sub>CC</sub> = 2.7 V   | 2.2              | -                  | -   | 2.2               | -   | ns   |
|                    |                               | V <sub>CC</sub> = 3.0 V to 3.6 V                                      | 2.0              | 0.8                | -   | 2.0               | -   | ns   |
| t <sub>h</sub>     | hold time                     | nD to nCP; see <a href="#">Figure 7</a>                               |                  |                    |     |                   |     |      |
|                    |                               | V <sub>CC</sub> = 2.7 V   | 1.0              | -                  | -   | 1.0               | -   | ns   |
|                    |                               | V <sub>CC</sub> = 3.0 V to 3.6 V                                      | +1.0             | -0.2               | -   | 1.0               | -   | ns   |
| f <sub>max</sub>   | maximum frequency             | nCP; see <a href="#">Figure 7</a>                                     |                  |                    |     |                   |     |      |
|                    |                               | V <sub>CC</sub> = 2.7 V   | 83               | -                  | -   | 66                | -   | MHz  |
|                    |                               | V <sub>CC</sub> = 3.0 V to 3.6 V                                      | 150              | 250                | -   | 120               | -   | MHz  |
| t <sub>sk(o)</sub> | output skew time              | V <sub>CC</sub> = 3.0 V to 3.6 V <sup>[3]</sup>                       | -                | -                  | 1.0 | -                 | 1.5 | ns   |
| C <sub>PD</sub>    | power dissipation capacitance | per flip-flop; V <sub>I</sub> = GND to V <sub>CC</sub> <sup>[4]</sup> |                  |                    |     |                   |     |      |
|                    |                               | V <sub>CC</sub> = 3.3 V   | -                | 15                 | -   | -                 | -   | pF   |

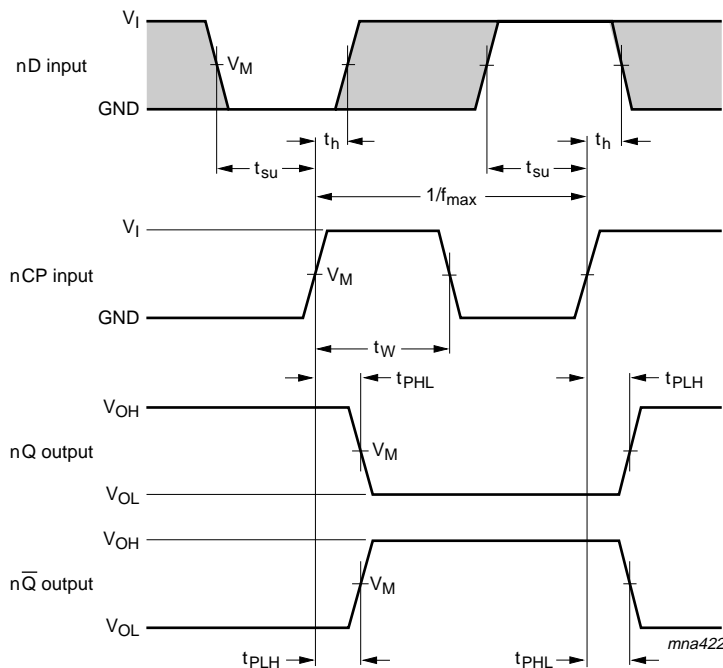
[1] Typical values are measured at T<sub>amb</sub> = 25 °C. For V<sub>CC</sub> = 3.0 V to 3.6 V range, typical values are measured at 3.3 V.

[2] t<sub>pd</sub> is the same as t<sub>PLH</sub> and t<sub>PHL</sub>.

[3] Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.

- [4]  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu W$ ).  
 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma(C_L \times V_{CC}^2 \times f_o)$  where:  
 $f_i$  = input frequency in MHz;  $f_o$  = output frequency in MHz  
 $C_L$  = output load capacitance in pF  
 $V_{CC}$  = supply voltage in Volts  
 $N$  = number of inputs switching  
 $\Sigma(C_L \times V_{CC}^2 \times f_o)$  = sum of the outputs

## 11. AC waveforms



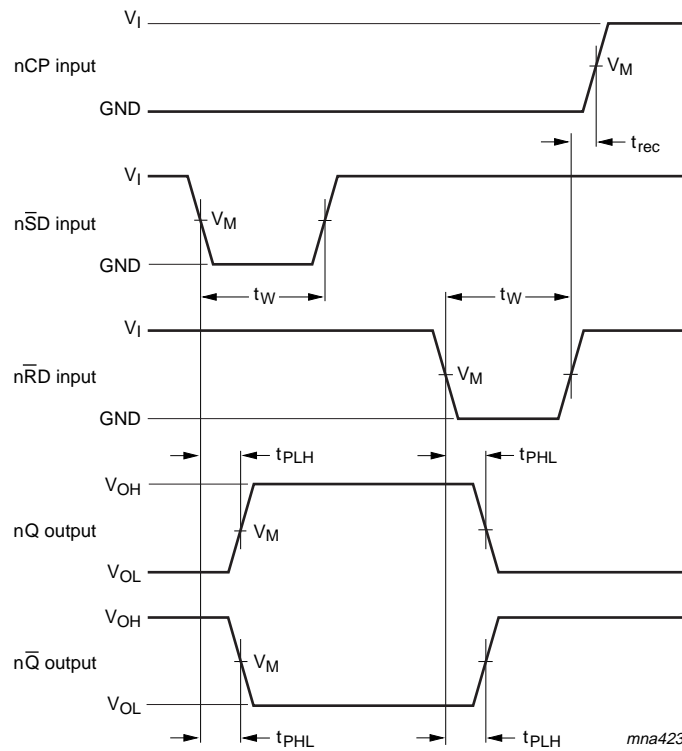
The shaded areas indicate when the input is permitted to change for predictable output performance.

$V_M = 1.5 V$  at  $V_{CC} \geq 2.7 V$ ;

$V_M = 0.5 \times V_{CC}$  at  $V_{CC} < 2.7 V$ ;

$V_{OL}$  and  $V_{OH}$  are typical output voltage levels that occur with the output load.

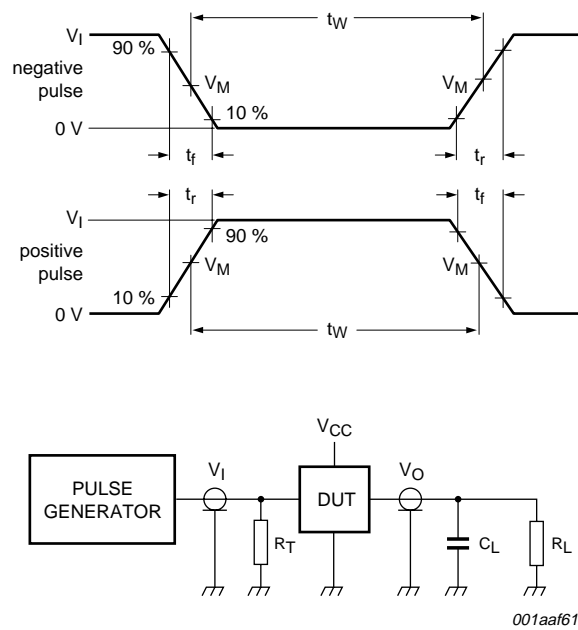
**Fig 7.** The clock input (nCP) to output (nQ, nQ-bar) propagation delays, the clock pulse width, the nD to nCP set-up, the nCP to nD hold times, and the maximum frequency



$V_M = 1.5\text{ V}$  at  $V_{CC} \geq 2.7\text{ V}$ ;  
 $V_M = 0.5 \times V_{CC}$  at  $V_{CC} < 2.7\text{ V}$ ;  
 $V_{OL}$  and  $V_{OH}$  are typical output voltage levels that occur with the output load.

**Fig 8.** The set ( $n\bar{S}D$ ) and reset ( $n\bar{R}D$ ) input to output ( $nQ$ ,  $n\bar{Q}$ ) propagation delays, the set and reset pulse widths, and the  $n\bar{R}D$  to  $nCP$  recovery time





001aaf615

Test data is given in [Table 9](#).

Definitions for test circuit:

$R_L$  = Load resistance.

$C_L$  = Load capacitance including jig and probe capacitance.

$R_T$  = Termination resistance should be equal to output impedance  $Z_o$  of the pulse generator.

**Fig 9. Load circuitry for switching times**

**Table 9. Test data**

| Supply voltage | Input    |               | Load  |              |
|----------------|----------|---------------|-------|--------------|
|                | $V_I$    | $t_r, t_f$    | $C_L$ | $R_L$        |
| 1.2 V          | $V_{CC}$ | $\leq 2.5$ ns | 50 pF | 500 $\Omega$ |
| 2.7 V          | 2.7 V    | $\leq 2.5$ ns | 50 pF | 500 $\Omega$ |
| 3.0 V to 3.6 V | 2.7 V    | $\leq 2.5$ ns | 50 pF | 500 $\Omega$ |

12. Package outline

SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1

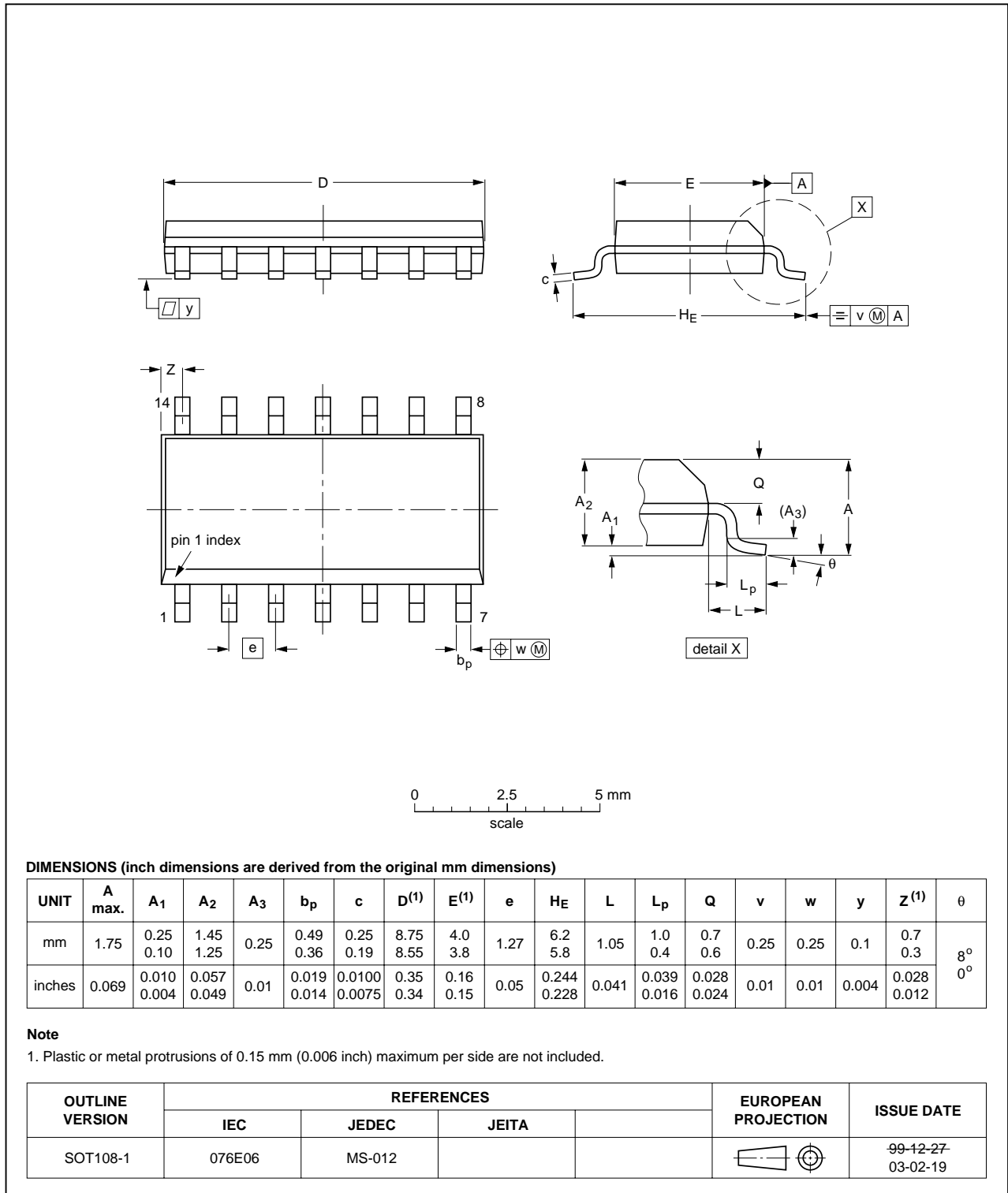


Fig 10. Package outline SOT108-1 (SO14)

SSOP14: plastic shrink small outline package; 14 leads; body width 5.3 mm

SOT337-1

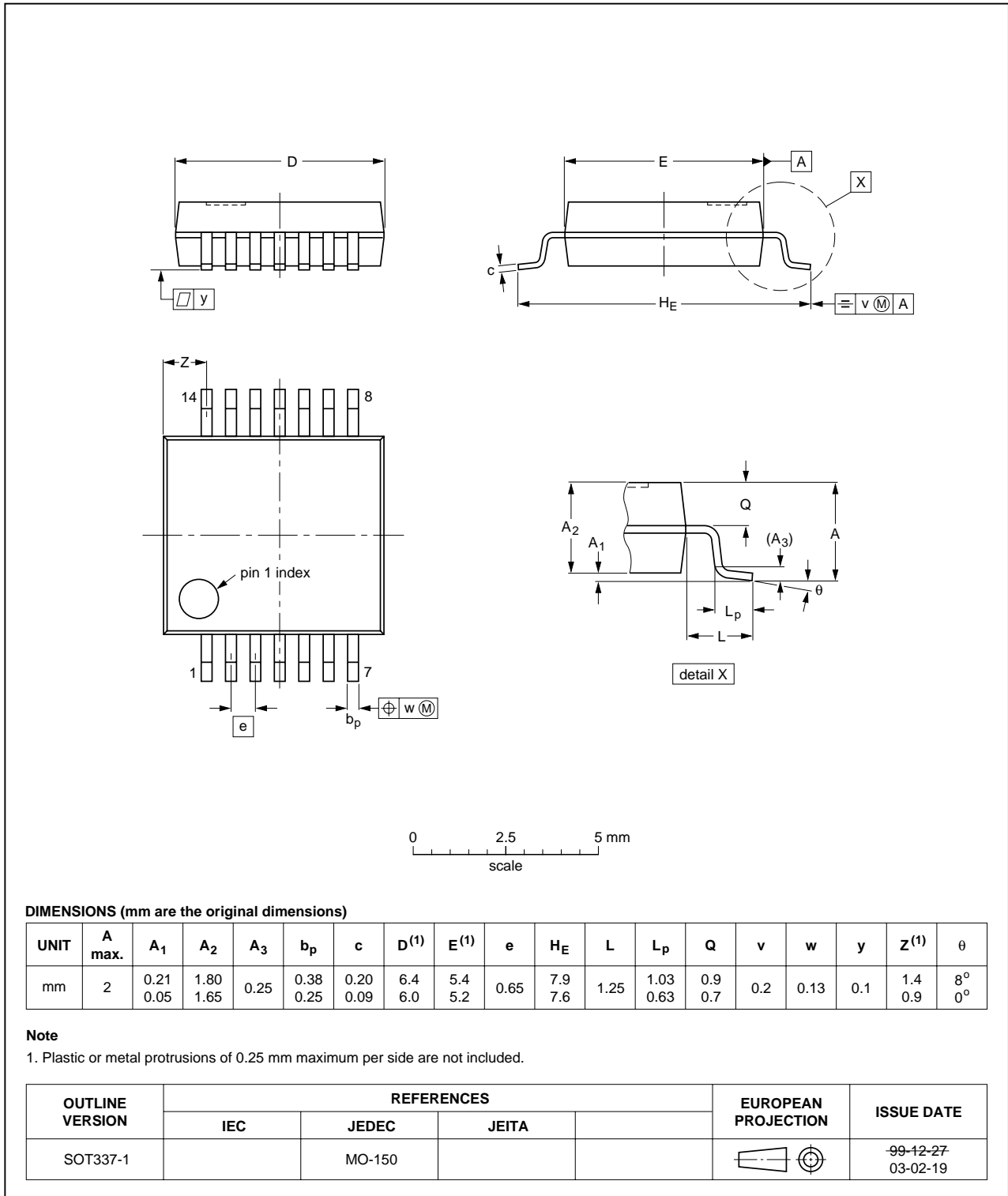


Fig 11. Package outline SOT337-1 (SSOP14)

TSSOP14: plastic thin shrink small outline package; 14 leads; body width 4.4 mm

SOT402-1

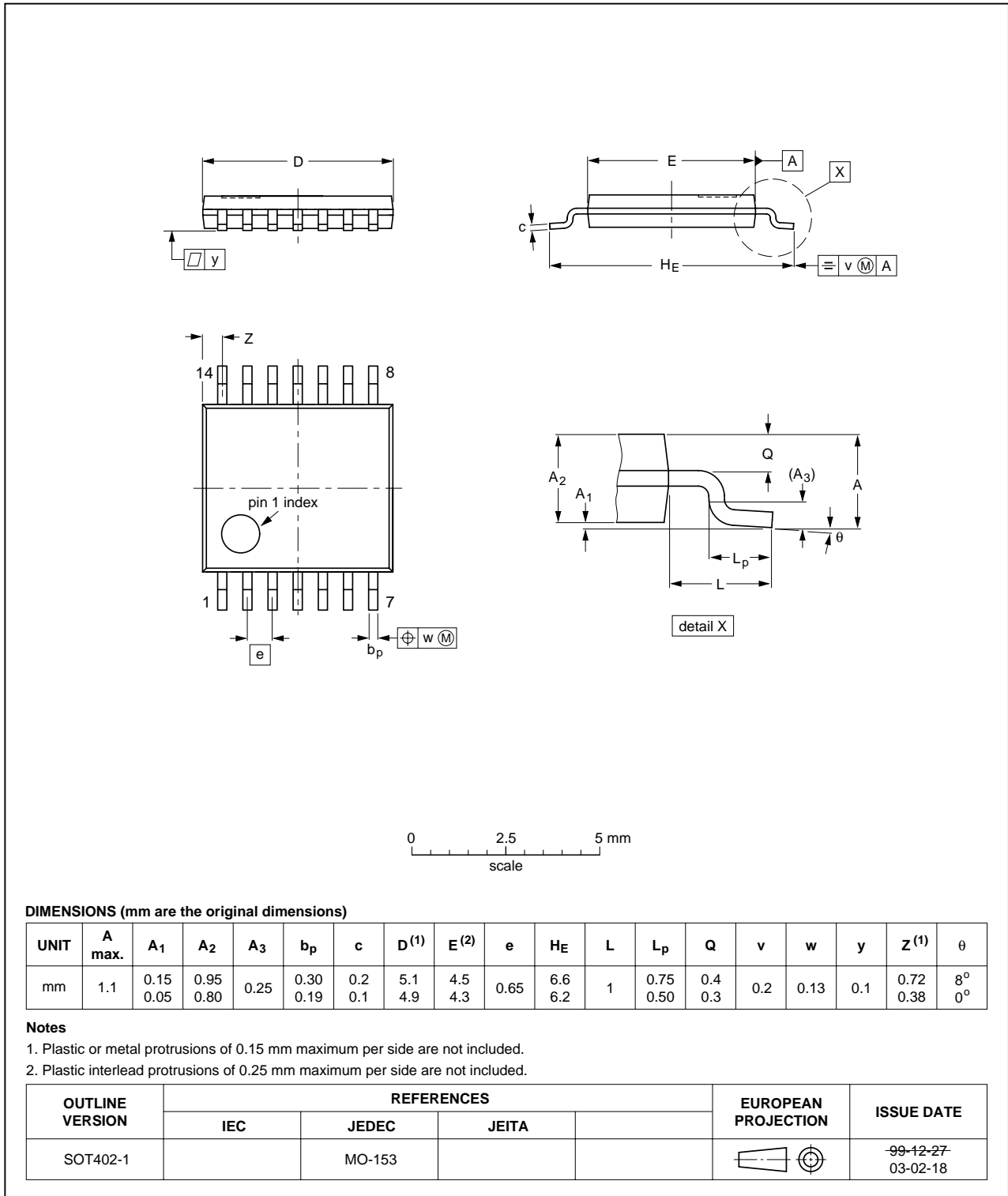


Fig 12. Package outline SOT402-1 (TSSOP14)

DHVQFN14: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body 2.5 x 3 x 0.85 mm

SOT762-1

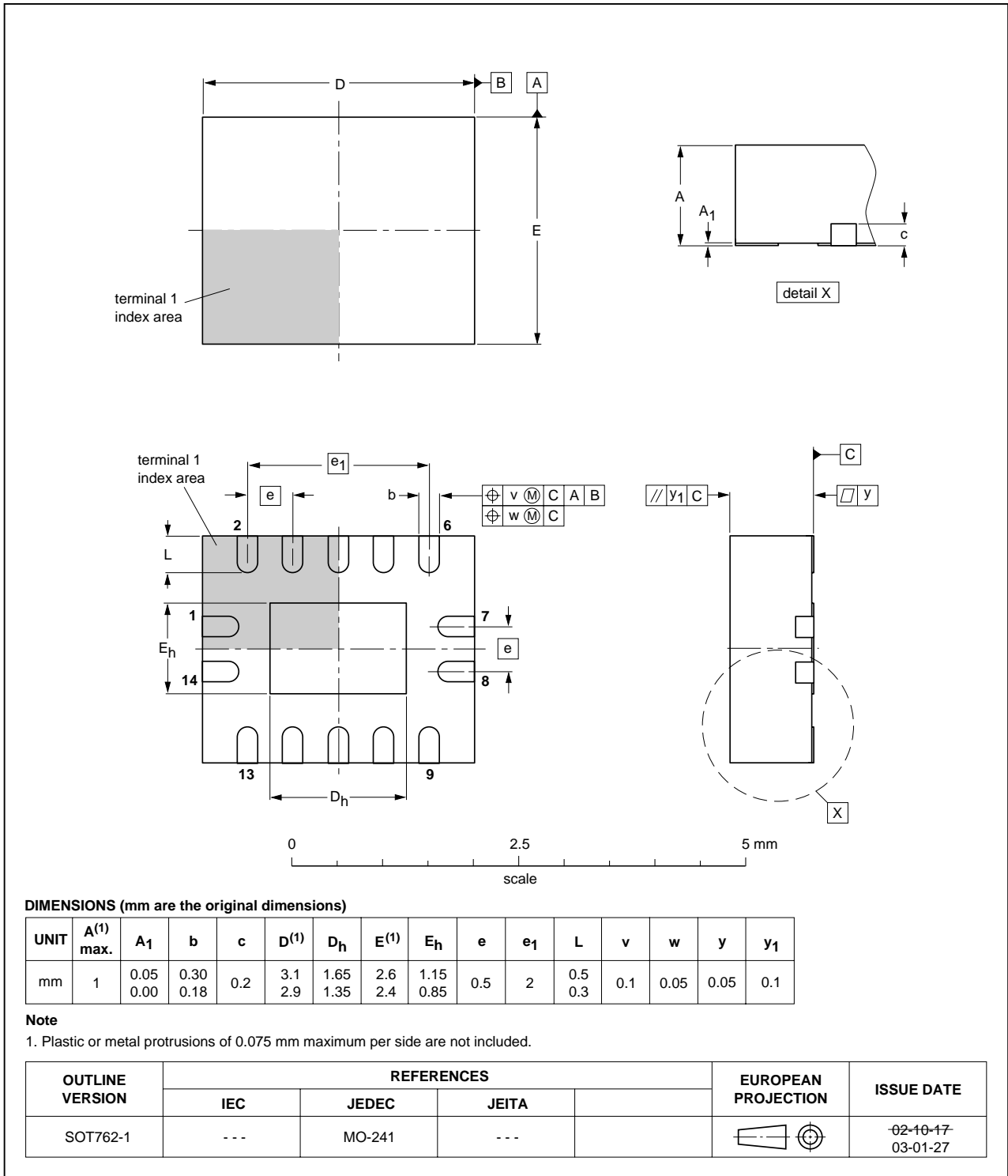


Fig 13. Package outline SOT762-1 (DHVQFN14)

## 13. Abbreviations

Table 10. Abbreviations

| Acronym | Description                 |
|---------|-----------------------------|
| CDM     | Charged Device Model        |
| DUT     | Device Under Test           |
| ESD     | ElectroStatic Discharge     |
| HBM     | Human Body Model            |
| TTL     | Transistor-Transistor Logic |

## 14. Revision history

Table 11. Revision history

| Document ID    | Release date  | Data sheet status     | Change notice | Supersedes |
|----------------|---|-----------------------|---------------|------------|
| 74LVC74A_6     | 20070604  | Product data sheet    | -             | 74LVC74A_5 |
| Modifications: | <ul style="list-style-type: none"> <li>Change of hold time in <a href="#">Table 8 "Dynamic characteristics"</a>. Minimum values changed to 1.0 ns.</li> </ul> |                       |               |            |
| 74LVC74A_5     | 20070525  | Product data sheet    | -             | 74LVC74A_4 |
| 74LVC74A_4     | 20030526  | Product specification | -             | 74LVC74A_3 |
| 74LVC74A_3     | 20020618  | Product specification | -             | 74LVC74A_2 |
| 74LVC74A_2     | 19980617  | Product specification | -             | 74LVC74A_1 |
| 74LVC74A_1     | 19980617  | Product specification | -             | -          |

## 15. Legal information

### 15.1 Data sheet status

| Document status <sup>[1][2]</sup> | Product status <sup>[3]</sup> | Definition  |
|-----------------------------------|-------------------------------|---|
| Objective [short] data sheet      | Development                   | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet    | Qualification                 | This document contains data from the preliminary specification.                       |
| Product [short] data sheet        | Production                    | This document contains the product specification.                                     |

[1] Please consult the most recently issued document before initiating or completing a design.

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